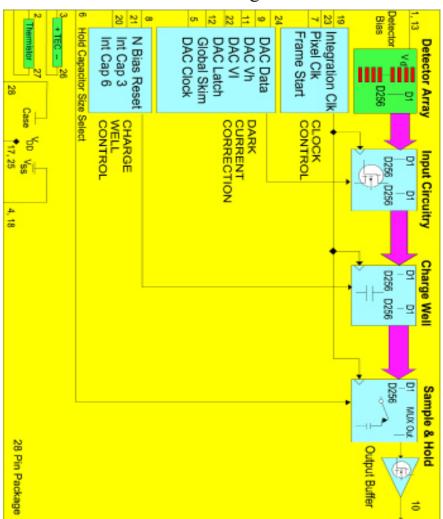
Cal Sensors 256 Element Multiplexed Array Functional Diagram



USB Interface Board Features & Specifications

■ USB interface to controller

Can be controlled by software commands with supplied driver

- Simple command structure interface
- On-board microcontroller controls all multiplexed array functions

Cooler control to set point temperature

All multiplexed timing and control voltages

Detector bias voltage

A/D converter control

Storage of all control and correction coefficients in non-volatile memory Automatic reload at power-up

- 16 bit A/D conveter at 500k samples/sec
- Efficient, high current PWM cooler drive FET requires no additional heatsinking

Synchronization with A/D conversion ensures low noise

■ Simple power requirements

12V@100mA

4 to 6 volts @1.5A

- Small size: 2.1" x 1.4" x 0.4"
- Direct interface to standard 28 pin package

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Our Sales Representative Near You:

256 ELEMENT MULTIPLEXED ARRAYS FOR SPECTROSCOPY



Lead Selenide (PbSe) Lead Sulfide (PbS)



PbS and PbSe Multiplexed Array Features:

- The low profile package features a detector with high aspect ratio pixels on 50 micron centers.
- The internal electronics provide variable integration and dark current correction.
- Temperature stabilization is achieved using an internal thermoelectric cooler and thermistor.
- This product is designed for low cost spectroscopic applications in the 1 to 5 micron wavelength region for PbSe and 1 to 3 microns for PbS.
- The internal multiplexer includes a serial readout up to 4 MHz and a global plus 8 bit per pixel dark current correction.
- Signal integration is variable with adjustable well size and can be generated before or during
- The array package is supplied with a compact USB controller board (optional) for easy computer interface.
- Multiplexed arrays installed into spectrometers have proven to be reliable and are cost effective alternatives to InGaAs detector material.
- Can be supplied as a development system.

256 Element PbSe Multiplexed Array Performance

Typical Performance: Parameter:

Operating Wavelength Range: 1 to 5 Microns

Number of Elements: 256 detector elements Element Size:

Pixel width 40 microns, pixel height 450 microns, and pixel pitch 50 microns

 $D^*: 1.0 \times 10^{10} \text{ (cmHz} ^0.5/W^{-1})$ Peak Detectivity: Resistance Uniformity (pixel-to-pixel): ±15% of array signal mean

Integration Range: .01mS to 200mS (on board) Pixel Clock: 2MHz max. for 4MHz data output

Linearity:

Pixel Operability: 98% minimum **Detector Rise Time:** $<10\mu S$

Input Power Requirement: 7 VDC mux, 8VDC cooler 1.7A max

256 Element PbS Multiplexed Array Performance

Parameter: Operating Wavelength Range:

Number of Elements:

Element Size:

Peak Detectivity:

Resistance Uniformity (pixel-to-pixel):

Integration Range: Pixel Clock: Linearity:

Pixel Operability:

Detector Rise Time:

Input Power Requirement:

Typical Performance:

1 to 3 Microns 256 detector elements

Pixel width 40 microns, pixel height 450 microns, and pixel pitch 50 microns

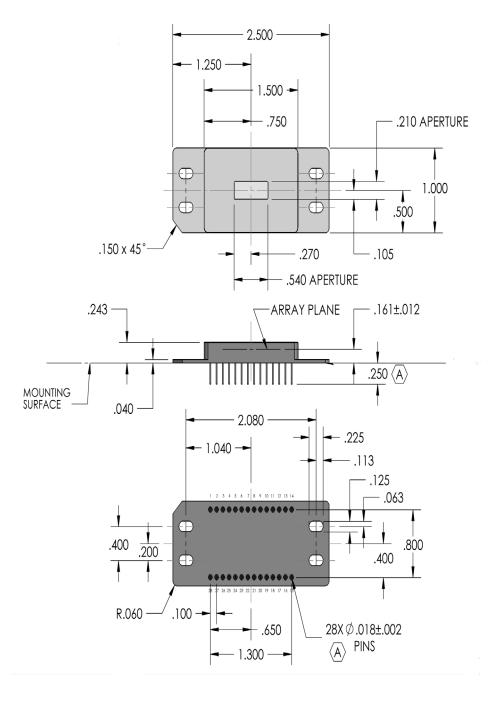
 $D^* : 1.0 \times 10^{11} \text{ (cmHz } ^0.5/\text{W}^{-1}\text{)}$

±10% of array signal mean .01 mS to 200mS (on board) 2MHz max. for 4MHz data output

98% minimum

<1mS

7 VDC mux, 8VDC cooler 1.7A max



PIN # FUNCTION

1 DETECTOR BIAS	10 MUX OUT	19 INT CLK
2 THERMISTOR A	11 DAC VI	20 NC
3 TEC (+)	12 GLOBAL SKIM	21 NC
4 NC	13 DET BIAS	22 DAC LOAD CLK
5 SERIAL CLK	14 NO CONNECTION	23 PIXEL CLK
6 CFG LOAD CLK	15 NO CONNECTION	24 SERIAL DATA
7 FRAME START	16 NO CONNECTION	25 NC
8 N BIAS RST	17 Vdd	26 TEC (-)
9 DAC Vh	18 Vss	27 THERMISTOR B
		28 CASE

See website for descriptions of pin functions.

System Timing Diagrams

Serial Control Register Timing Diagram

